

CHINA DEVELOPMENT BANK BENCHMARK BOND ISSUANCE PROGRAMME TENDER ANNOUNCEMENT

11 January 2023

230213 Issue Number Tender Type New Issue **Tender Date** 12 January 2023 **Tender Time** 14:30 pm to 15:30 pm Renminbi 2 Billion Offering Amount Interest Type **Floating** Coupon Rate Determined at Auction **Interest Payment Frequency** Annually 16 April, 16 July, 16 October, 16 January **Interest Payment Date** Original Tenor Three Years Maturity Date 16 January 2026 Issue and Settlement Date 16 January 2023 Dated Date(Value Date) 16 January 2023 Listing Date 18 January 2023 Clearing House China Central Depository & Clearing Co.,Ltd China's Inter-bank Bond Market(CIBM) Market Exempted for issuance in CIBM Rating

For offshore issuance, China's Quasi-sovereign ratings, i.e. Moody's: A1(Stable), S&P: A+(Stable)

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CDB's bond yield curve available at http://www.cdb.com.cn.